

International **IR** Rectifier

PD -95190

IRG4PH50UDPbF

INSULATED GATE BIPOLAR TRANSISTOR WITH ULTRAFAST SOFT RECOVERY DIODE

UltraFast CoPack IGBT

Features

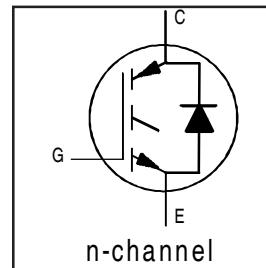
- UltraFast: Optimized for high operating frequencies up to 40 kHz in hard switching, >200 kHz in resonant mode
- New IGBT design provides tighter parameter distribution and higher efficiency than previous generations
- IGBT co-packaged with HEXFRED™ ultrafast, ultra-soft-recovery anti-parallel diodes for use in bridge configurations
- Industry standard TO-247AC package
- Lead-Free

Benefits

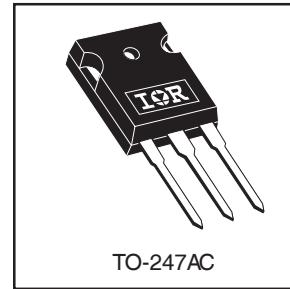
- Higher switching frequency capability than competitive IGBTs
- Highest efficiency available
- HEXFRED diodes optimized for performance with IGBT's. Minimized recovery characteristics require less/no snubbing

Absolute Maximum Ratings

	Parameter	Max.	Units
V_{CES}	Collector-to-Emitter Breakdown Voltage	1200	V
$I_C @ T_C = 25^\circ C$	Continuous Collector Current	45	A
$I_C @ T_C = 100^\circ C$	Continuous Collector Current	24	
I_{CM}	Pulsed Collector Current ①	180	
I_{LM}	Clamped Inductive Load Current ②	180	
$I_F @ T_C = 100^\circ C$	Diode Continuous Forward Current	16	
I_{FM}	Diode Maximum Forward Current	180	
V_{GE}	Gate-to-Emitter Voltage	± 20	V
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	200	W
$P_D @ T_C = 100^\circ C$	Maximum Power Dissipation	78	
T_J	Operating Junction and	-55 to + 150	$^\circ C$
T_{STG}	Storage Temperature Range		
	Soldering Temperature, for 10 seconds	300 (0.063 in. (1.6mm) from case)	
	Mounting torque, 6-32 or M3 screw.	10 lbf·in (1.1N·m)	



$V_{CES} = 1200V$
 $V_{CE(on)} \text{ typ.} = 2.78V$
@ $V_{GE} = 15V, I_C = 24A$



Thermal Resistance

	Parameter	Min.	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case - IGBT	—	—	0.64	$^\circ C/W$
$R_{\theta JC}$	Junction-to-Case - Diode	—	—	0.83	
$R_{\theta CS}$	Case-to-Sink, flat, greased surface	—	0.24	—	
$R_{\theta JA}$	Junction-to-Ambient, typical socket mount	—	—	40	
Wt	Weight	—	6 (0.21)	—	g (oz)

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Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(\text{BR})\text{CES}}$	Collector-to-Emitter Breakdown Voltage ^③	1200	—	—	V	$V_{\text{GE}} = 0\text{V}$, $I_C = 250\mu\text{A}$
$\Delta V_{(\text{BR})\text{CES}/\Delta T_J}$	Temperature Coeff. of Breakdown Voltage	—	1.20	—	V/ $^\circ\text{C}$	$V_{\text{GE}} = 0\text{V}$, $I_C = 1.0\text{mA}$
$V_{\text{CE}(\text{on})}$	Collector-to-Emitter Saturation Voltage	—	2.56	3.5	V	$I_C = 20\text{A}$ $V_{\text{GE}} = 15\text{V}$
		—	2.78	3.7		$I_C = 24\text{A}$
		—	3.20	—		$I_C = 45\text{A}$ See Fig. 2, 5
		—	2.54	—		$I_C = 24\text{A}$, $T_J = 150^\circ\text{C}$
$V_{\text{GE}(\text{th})}$	Gate Threshold Voltage	3.0	—	6.0		$V_{\text{CE}} = V_{\text{GE}}$, $I_C = 250\mu\text{A}$
$\Delta V_{\text{GE}(\text{th})/\Delta T_J}$	Temperature Coeff. of Threshold Voltage	—	-13	—	mV/ $^\circ\text{C}$	$V_{\text{CE}} = V_{\text{GE}}$, $I_C = 250\mu\text{A}$
g_{fe}	Forward Transconductance ^④	23	35	—	S	$V_{\text{CE}} = 100\text{V}$, $I_C = 24\text{A}$
I_{CES}	Zero Gate Voltage Collector Current	—	—	250	μA	$V_{\text{GE}} = 0\text{V}$, $V_{\text{CE}} = 1200\text{V}$
		—	—	6500		$V_{\text{GE}} = 0\text{V}$, $V_{\text{CE}} = 1200\text{V}$, $T_J = 150^\circ\text{C}$
V_{FM}	Diode Forward Voltage Drop	—	2.5	3.5	V	$I_C = 16\text{A}$ See Fig. 13
		—	2.1	3.0		$I_C = 16\text{A}$, $T_J = 150^\circ\text{C}$
I_{GES}	Gate-to-Emitter Leakage Current	—	—	± 100	nA	$V_{\text{GE}} = \pm 20\text{V}$

Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
Q_g	Total Gate Charge (turn-on)	—	160	250	nC	$I_C = 24\text{A}$
Q_{ge}	Gate - Emitter Charge (turn-on)	—	27	40		$V_{\text{CC}} = 400\text{V}$ See Fig. 8
Q_{gc}	Gate - Collector Charge (turn-on)	—	53	80		$V_{\text{GE}} = 15\text{V}$
$t_{d(\text{on})}$	Turn-On Delay Time	—	47	—	ns	$T_J = 25^\circ\text{C}$
t_r	Rise Time	—	24	—		$I_C = 24\text{A}$, $V_{\text{CC}} = 800\text{V}$
$t_{d(\text{off})}$	Turn-Off Delay Time	—	110	170		$V_{\text{GE}} = 15\text{V}$, $R_G = 5.0\Omega$
t_f	Fall Time	—	180	260		Energy losses include "tail" and diode reverse recovery. See Fig. 9, 10, 18
E_{on}	Turn-On Switching Loss	—	2.10	—	mJ	
E_{off}	Turn-Off Switching Loss	—	1.50	—		
E_{ts}	Total Switching Loss	—	3.60	4.6		
$t_{d(\text{on})}$	Turn-On Delay Time	—	46	—	ns	$T_J = 150^\circ\text{C}$, See Fig. 11, 18
t_r	Rise Time	—	27	—		$I_C = 24\text{A}$, $V_{\text{CC}} = 800\text{V}$
$t_{d(\text{off})}$	Turn-Off Delay Time	—	240	—		$V_{\text{GE}} = 15\text{V}$, $R_G = 5.0\Omega$
t_f	Fall Time	—	330	—		Energy losses include "tail" and diode reverse recovery.
E_{ts}	Total Switching Loss	—	6.38	—	mJ	
L_E	Internal Emitter Inductance	—	13	—	nH	Measured 5mm from package
C_{ies}	Input Capacitance	—	3600	—	pF	$V_{\text{GE}} = 0\text{V}$
C_{oes}	Output Capacitance	—	160	—		$V_{\text{CC}} = 30\text{V}$ See Fig. 7
C_{res}	Reverse Transfer Capacitance	—	31	—		$f = 1.0\text{MHz}$
t_{rr}	Diode Reverse Recovery Time	—	90	135	ns	$T_J = 25^\circ\text{C}$ See Fig.
		—	164	245		$T_J = 125^\circ\text{C}$ 14
I_{rr}	Diode Peak Reverse Recovery Current	—	5.8	10	A	$T_J = 25^\circ\text{C}$ See Fig.
		—	8.3	15		$T_J = 125^\circ\text{C}$ 15
Q_{rr}	Diode Reverse Recovery Charge	—	260	675	nC	$T_J = 25^\circ\text{C}$ See Fig.
		—	680	1838		$T_J = 125^\circ\text{C}$ 16
$di_{(\text{rec})M}/dt$ During t_b	Diode Peak Rate of Fall of Recovery	—	120	—	A/ μs	$T_J = 25^\circ\text{C}$ See Fig.
		—	76	—		$T_J = 125^\circ\text{C}$ 17

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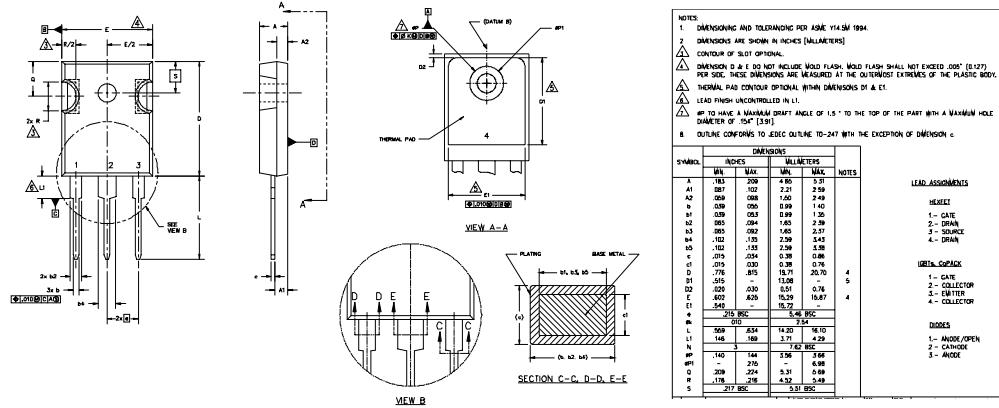
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Notes:

- ① Repetitive rating: $V_{GE}=20V$; pulse width limited by maximum junction temperature (figure 20)
 - ② $V_{CC}=80\%(V_{CES})$, $V_{GE}=20V$, $L=10\mu H$, $R_G=5.0\Omega$ (figure 19)
 - ③ Pulse width $\leq 80\mu s$; duty factor $\leq 0.1\%$.
 - ④ Pulse width $5.0\mu s$, single shot.

TO-247AC Package Outline

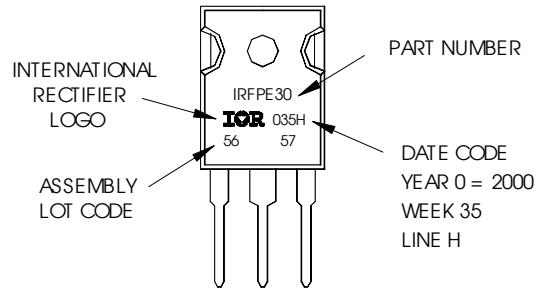
Dimensions are shown in millimeters (inches)



TO-247AC Part Marking Information

EXAMPLE: THIS IS AN IRFPE30
WITH ASSEMBLY
LOT CODE 5657
ASSEMBLED ON WV 35, 2000
IN THE ASSEMBLY LINE "H"

Note: "P" in assembly line position indicates "Lead-Free"



Data and specifications subject to change without notice.

International **ICR** Rectifier